
HVD136

Silicon Epitaxial Trench Pin Diode for Antenna Switching

HITACHI

ADE-208-949 (Z)

Rev. 0
Jul. 2000

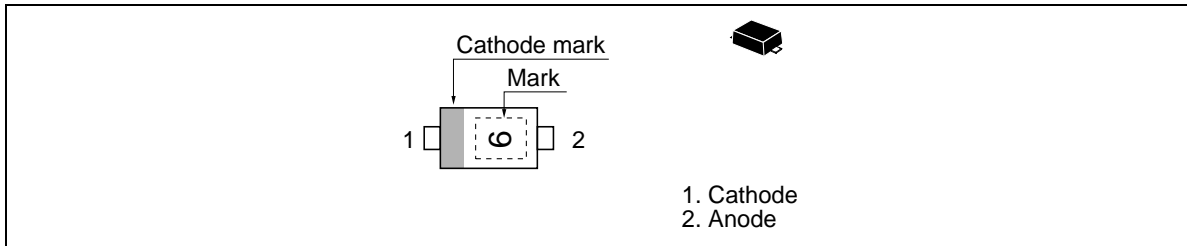
Features

- Adopting the trench structure improves low capacitance. ($C = 0.45 \text{ pF max}$)
- Low forward resistance. ($r_f = 2.5 \Omega \text{ max}$)
- Low operation current.
- Super small Flat Package (SFP) is suitable for surface mount design.

Ordering Information

| Type No. | Laser Mark | Package Code |
|----------|------------|--------------|
| HVD136 | 6 | SFP |

Outline



HVD136

Absolute Maximum Ratings

(Ta = 25°C)

| Item | Symbol | Value | Unit |
|----------------------|----------|-------------|------|
| Peak reverse voltage | V_{RM} | 65 | V |
| Reverse voltage | V_R | 60 | V |
| Forward current | I_F | 100 | mA |
| Power dissipation | Pd | 150 | mW |
| Junction temperature | Tj | 125 | °C |
| Storage temperature | Tstg | -55 to +125 | °C |

Electrical Characteristics

(Ta = 25°C)

| Item | Symbol | Min | Typ | Max | Unit | Test Condition |
|--------------------|--------|-----|-----|------|------|--|
| Reverse current | I_R | — | — | 0.1 | μA | $V_R = 60$ V |
| Forward voltage | V_F | — | — | 0.9 | V | $I_F = 2$ mA |
| Capacitance | C | — | — | 0.45 | pF | $V_R = 1$ V, f = 1 MHz |
| Forward resistance | r_f | — | — | 2.5 | Ω | $I_F = 2$ mA, f = 100 MHz |
| ESD-Capability *1 | — | 100 | — | — | V | C = 200 pF, R = 0 Ω, Both forward and reverse direction 1 pulse. |

Notes : 1. Failure criterion ; $I_R > 100$ nA at $V_R = 60$ V

2. Please do not use the soldering iron due to avoid high stress to the SFP package.

Main Characteristic

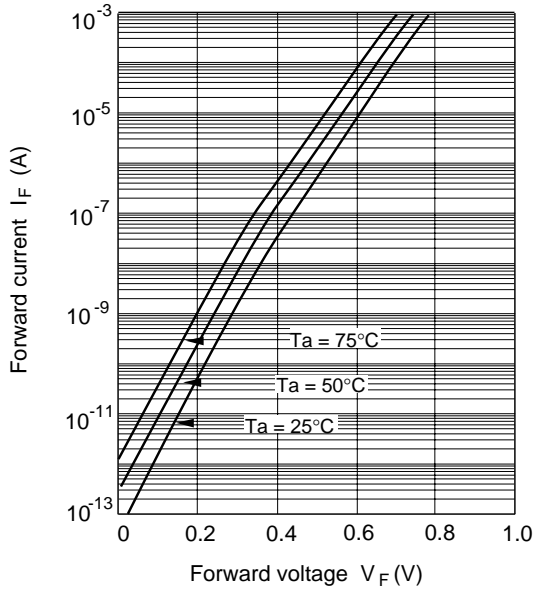


Fig.1 Forward current Vs. Forward voltage

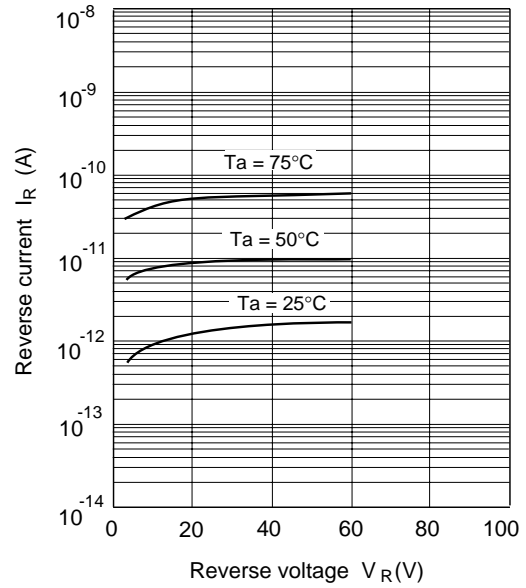


Fig.2 Reverse current Vs. Reverse voltage

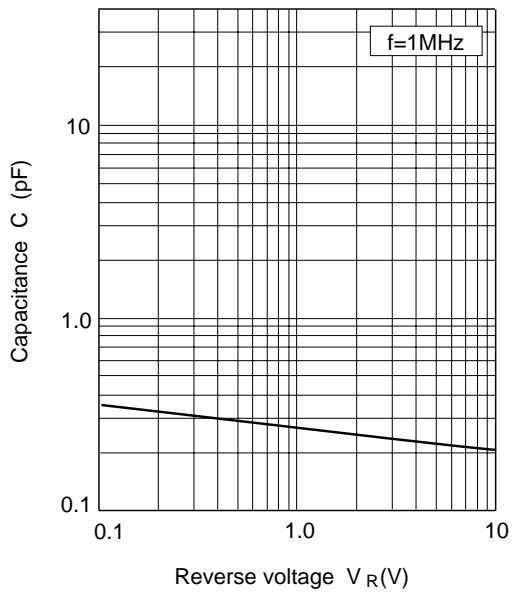


Fig.3 Capacitance Vs. Reverse voltage

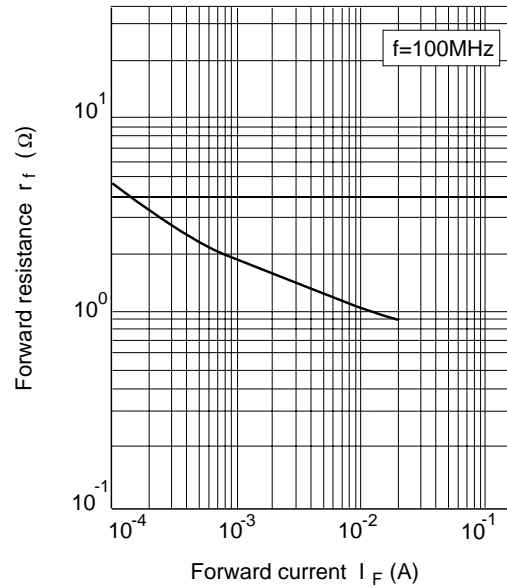


Fig.4 Forward resistance Vs. Forward current

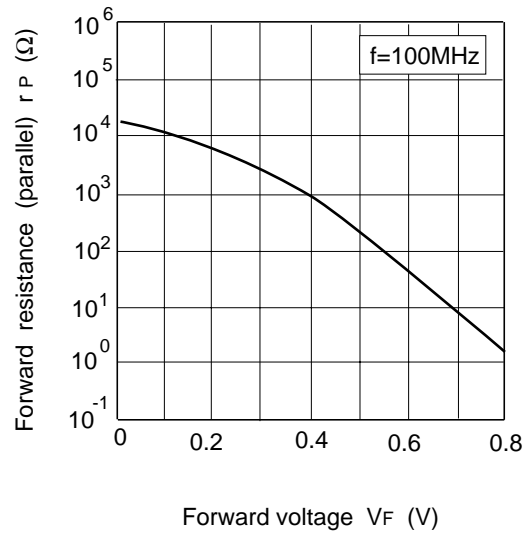
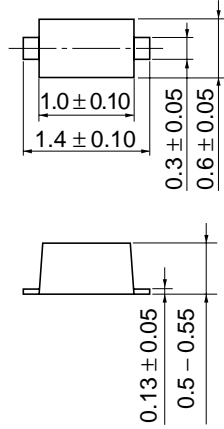


Fig.5 Forward resistance (parallel) Vs. Forward voltage

Package Dimensions

Unit: mm



| | |
|------------------------|----------|
| Hitachi Code | SFP |
| JEDEC | — |
| EIAJ | — |
| Mass (reference value) | 0.0010 g |

HVD136

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